



EU DECLARATION OF CONFORMITY

Model: SDC003 (Rosewood7 2D)

I. Product Safety and EMC Compliance

- A. The Electromagnetic Compatibility (EMC) Directive 2014/30/EU by application of the following standards:

EN 55032:2012/AC: 2013	Electromagnetic compatibility of multimedia equipment — Emission requirements.
EN 55024:2010	Information technology equipment – Immunity characteristics – Limits and methods of measurement.
EN 61000-3-2:2014	Electromagnetic compatibility (EMC) - Part 3-2: Limits for harmonic current emissions (equipment input current ≤ 16 A per phase).
EN 61000-3-3:2013	Electromagnetic compatibility (EMC) - Part 3-3: Limitation of voltage changes, voltage fluctuations and flicker in public low-voltage supply systems, for equipment with rated current ≤ 16 A per phase.

- B. The product (s) meets the requirements of The Low Voltage Directive (LVD) 2014/35/EU by application of the following standard(s):

EN 60950-1:2006	Information technology equipment - Safety - General requirements. (Second Edition) Part 1: +A11:2009 +A1:2010 +A12:2011+ A2:2013.
EN 62368-1:2014	Audio/video, information and communication technology equipment – Part 1: Safety requirements (IEC 62368-1:2014, modified)

II. Product Environmental Compliance, EU/China RoHS Declaration of Conformity

- A. Conformity with Harmonized Standards/Technical Specifications:

1. Directive 2011/65/EU RoHS “Recast” (RoHS 2) as amended by Directive (EU) 2015/863 and further amended by Directive 2018/739 and Directive 2018/740 EN 50581:2012
2. Management Methods for Controlling Pollution by Electronic Information Products, Ministry of Information Industry Order No. 39 (China RoHS)
3. Management Methods for the Restriction of the Use of Hazardous Substances in electrical and Electronic Products, Ministry of Industry and Information Technology Order No. 32 effective July 1, 2016 (China RoHS 2)
4. Joint JEDEC/ECA Standard, Definition of “Low-Halogen” for Electronic Products, JS709B

B. Seagate products rely on the following RoHS 2 exemptions for compliance:

Exemption Description
6(a)-I. Lead as an alloying element in steel for machining purposes containing up to 0.35% lead by weight and in batch hot dip galvanised steel components containing up to 0.2% lead by weight
6(b)-II. Lead as an alloying element in aluminum for machining purposes up to 0.4% lead by weight
6c. Copper alloy up to 0.4% lead by weight
7a. Lead in high melting temperature type solders (i.e. lead-based solder alloys containing 85 % by weight or more lead
7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors (e.g. piezoelectronic devices) or in a glass or ceramic matrix compound

This product or products are in conformity with the relevant Union harmonization legislation. This declaration of conformity is issued under the sole responsibility of Seagate Technology International.

Date of Issue: Sep 24, 2018

Signature:



Azeez Talha
Engineering Director
Reliability Technology Engineering

Signed for and on behalf of:

Seagate Technology International
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